

# **DECLARATION AND POWER OF ATTORNEY FOR ORIGINAL U.S. PATENT APPLICATION**

Attorney's Docket No. NOVLP068/NVLS-000818

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **METHOD FOR FABRICATION OF SEMICONDUCTOR INTERCONNECT STRUCTURE WITH REDUCED CAPACITANCE, LEAKAGE CURRENT, AND IMPROVED BREAKDOWN VOLTAGE** the specification of which,

(check one)

1.  is attached hereto.
2.  was filed on \_\_\_\_\_ as  
U.S. Application No. \_\_\_\_\_  
and was amended on \_\_\_\_\_.
3.  was filed on \_\_\_\_\_ as  
International PCT Application No. \_\_\_\_\_  
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I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, CFR § 1.56.

## **Prior Foreign Application(s)**

I hereby claim foreign priority benefits under Title 35, United States code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

			Priority Benefits Claimed?
(Application No.)	(Country)	(Filing Date)	Yes ____ No ____
_____	_____	_____	Yes ____ No ____
_____	_____	_____	Yes ____ No ____

## **Provisional Application(s)**

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And I hereby appoint the law firm of **Beyer Weaver & Thomas, LLP** and all practitioners who are associated with the Customer Number 022434 as my principal attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

**Direct Correspondence To:**

**Customer Number: 022434**

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**Direct Telephone Calls To:**

**Jeffrey K. Weaver at telephone number (510) 843-6200**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Typewritten Full Name of

Sole or First Inventor:

Daniel A. Koos

Citizenship: United States

Inventor's signature:

Date of Signature: 10/6/03

Residence: (City)

Chandler

(State/Country) AZ/US

Post Office Address:

3780 W. Kesler Street, Chandler, AZ 85226

Second Inventor:

Steven T. Mayer

Citizenship: United States

Inventor's signature:

Date of Signature: 10/7/03

Residence: (City)

Lake Oswego

(State/Country) OR/US

Post Office Address:

17867 Sundown Court, Lake Oswego, OR 97034

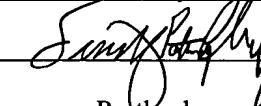
Third Inventor: Heung L. Park Citizenship: South Korea

Inventor's signature: \_\_\_\_\_ Date of Signature: \_\_\_\_\_

Residence: (City) Wilsonville (State/Country) OR/US

Post Office Address: 7563 SW Vlahos Drive, Wilsonville, OR 97070

Fourth Inventor: Timothy Patrick Cleary Citizenship: United States

Inventor's signature:  Date of Signature: 10-6-03

Residence: (City) Portland (State/Country) OR/US

Post Office Address: 6699 SE Scott Drive, Portland, OR 97215

Fifth Inventor: Thomas Mountsier Citizenship: United States

Inventor's signature: \_\_\_\_\_ Date of Signature: \_\_\_\_\_

Residence: (City) San Jose (State/Country) CA/US

Post Office Address: 331 South 17<sup>th</sup> Street, San Jose, CA 95112

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Citizenship: United States

Inventor's signature: \_\_\_\_\_

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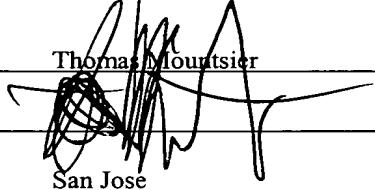
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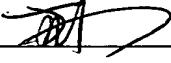
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